

Inrush Current Limiters (ICLs)

Series/Type: S30/\*/M

Ordering code: B57130S0\*M000

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Version:

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B57130S0\*M000

## **Inrush Current Limiters (ICLs)**

S30/\*/M

# **Applications**

Inrush current limiting, e.g. in switch-mode power supplies, soft-start motors

# A NTC 22433

## **Features**

- Leaded and coated NTC thermistors
- Tinned copper wire
- Coating material flame retardant to UL 94 V-0
- Component marking includes the manufacturer's logo, resistance value and data code
- Highly stable electrical characteristics

## **Options**

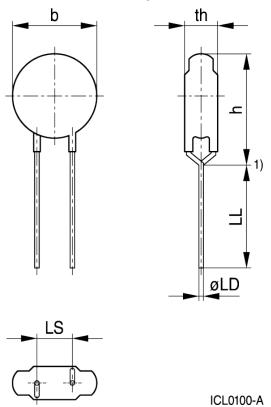
Resistance tolerance < 25% available on request

# **Delivery mode**

Bulk

S30/\*/M

# Dimensional drawings in mm



b	33 max mm	
th	10 max	mm
h	40 max	mm
LL	25.0 min. <sup>2)</sup>	mm
LD	1.0 ±0.05	mm
LS	7.5 ±0.8	mm

<sup>&</sup>lt;sup>2)</sup> Effective Lead length acc. taping spec. IEC 60286-2

Approx. weight: 20 g

## General technical data

Climatic category	(IEC 60068-1)		55/170/21	
Max. power	(at 25 °C)	P <sub>max</sub>	19.0	W
Resistance tolerance		$\Delta R_R/R_R$	±25	%
Rated temperature		TR	25	°C
Dissipation factor	(in air)	$\delta_{\text{th}}$	approx. 75	mW/K
Thermal cooling time constan	t (in air)	τth	approx. 240	s
Heat capacity		Cth	approx. 18000	mJ/K

<sup>1)</sup> Seating plane to IEC 60717



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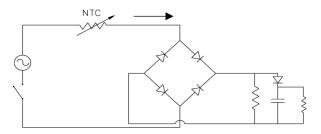
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# Electrical specification and ordering codes

R <sub>25</sub>	I <sub>max</sub>	Ctest	Ctest	Max	R <sub>min</sub>	Ordering code
	(0 25 °C)	at 240 V AC	at 120 V AC	Energy	(at I <sub>max</sub> , 25 °C)	
Ω	Α	μF	μF	J	Ω	
2	25	5210	20840	300	0.027	B57130S0209M000
4	23	3500	14000	200	0.036	B57130S0409M000
5	20	3500	14000	200	0.043	B57130S0509M000
10	15	4370	17480	250	0.079	B57130S0100M000
15	12	4370	17480	250	0.114	B57130S0150M000

Remark:  $I_{\text{max}}$  and  $C_{\text{test}}$  refer to the following test method.



Ctest Test capacitance [µF]

I<sub>max</sub> Max current across the NTC under test [A]

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## Maximum continuous current I<sub>max</sub>

The  $I_{max}$  denotes the maximum permissible continuous current (DC or RMS values for sine-shaped AC) in the temperature range from 0 to 25 °C.

## Load derating (I/I<sub>max</sub>)

The power handling capability of an NTC thermistor cannot be fully utilized over the entire temperature range. For circuit dimensioning the derating curve given below provides information on the extent to which the current must be reduced at a certain ambient temperature ( $T_A$ ).

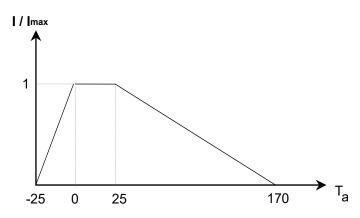


Fig. 1: Maximum current derating (I/I<sub>max</sub>)

Percent of I<sub>max</sub> = 
$$100 \left[ 1 - \frac{T_A - 25^{\circ}C}{T_{\text{max}} - 25^{\circ}C} \right]$$

 $T_A$  = ambient temperature ( $T_A$  > 25 °C)

$$T_{max} = 170 \, ^{\circ}C$$

## Marking

- EPCOS brand logo
- Resistance value
- NTC
- Date code with 4 digits (year and week of production),
   e. g. 2236 stands for week 36 of the year 2022.



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## **Inrush Current Limiters (ICLs)**

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## Reliability data

Test	Standard	Test conditions	ΔR <sub>25</sub> / R <sub>25</sub>   (typical)	Remarks
Storage in dry heat	IEC 60068-2-2	Storage at upper category temperature T: 170 °C t: 1000 h	< 20%	No visible damage
Storage in damp heat, steady state	IEC 60068-2-78	Temperature of air: 40 °C Relative humidity of air: 93% Duration: 21 days	< 20%	No visible damage
Rapid change of temperature	IEC 60068-2-14	Lower test temperature: -55 °C t: 30 min Upper test temperature: 170 °C t: 30 min Time to change from lower to upper temperature: < 30 s Number of cycles: 10	< 20%	No visible damage
Endurance	Specification Standard	Ambient temperature: 25 ±5 °C I = Imax On-time = 1 min Cooling time = 5 min Ctest = Capacitance at 240 V AC Number of cycles: 100	< 20%	No visible damage

#### **Notes**

- The self-heating of a thermistor during operation depends on the load applied and the applicable dissipation factor.
- When loaded with maximum allowable current/power and the specified dissipation factor is taken as a basis, the NTC thermistor may reach a mean temperature of up to 250 °C.
- The heat developed during operation will also be dissipated through the lead wires. Therefore, the contact areas may also become quite hot at maximum load.
- When mounting NTC thermistors you have to ensure that there is an adequate distance between the thermistor and all parts which are sensitive to heat or combustible.



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## **Inrush Current Limiters (ICLs)**

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## **Solderability**

Test to IEC 60068-2-20

Preconditioning: immersion into flux F-SW 32.

Evaluation criterion: wetting of soldering areas ≥ 95%.

Solder	Bath temperature (°C)	Dwell time (s)
SnAg (3.0 4.0), Cu (0.5 0.9)	245 ±3	3

## Resistance to soldering heat

Test to IEC 60068-2-20

Preconditioning: Immersion into flux F-SW 32.

Solder	Bath temperature (°C)	Dwell time (s)
SnAg (3.0 4.0), Cu (0.5 0.9)	260 -5	10

## Soldering instructions

When soldering, care must be taken that the NTC thermistors are not damaged by excessive heat. The following maximum temperatures, maximum time spans and minimum distances have to be observed:

	Dip soldering	Iron soldering
Bath temperature:	max. 260 °C	max. 360 °C
Soldering time:	max. 4 s	max. 2 s
Distance from thermistor:	min. 6 mm	min. 6 mm

Under more severe soldering conditions the resistance may change.



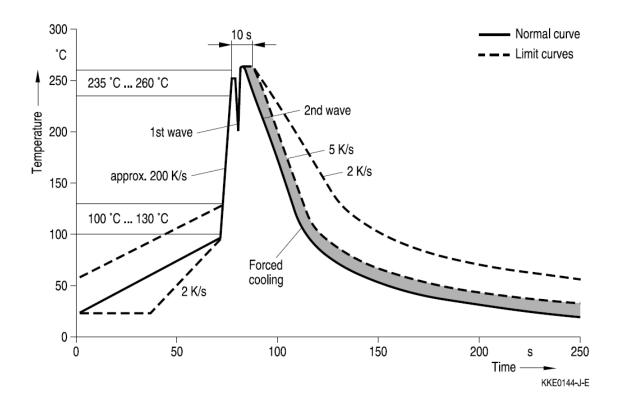
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# **Inrush Current Limiters (ICLs)**

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# Wave soldering

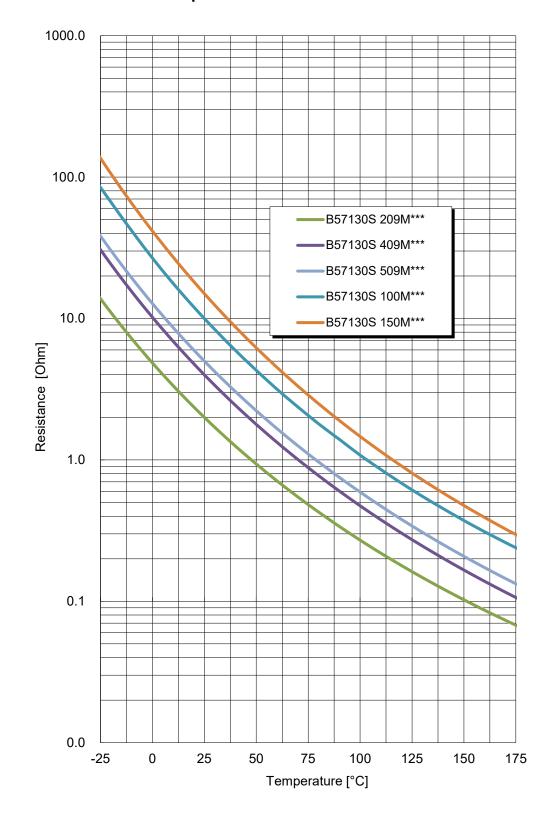
Temperature characteristic at component terminal with dual wave soldering.





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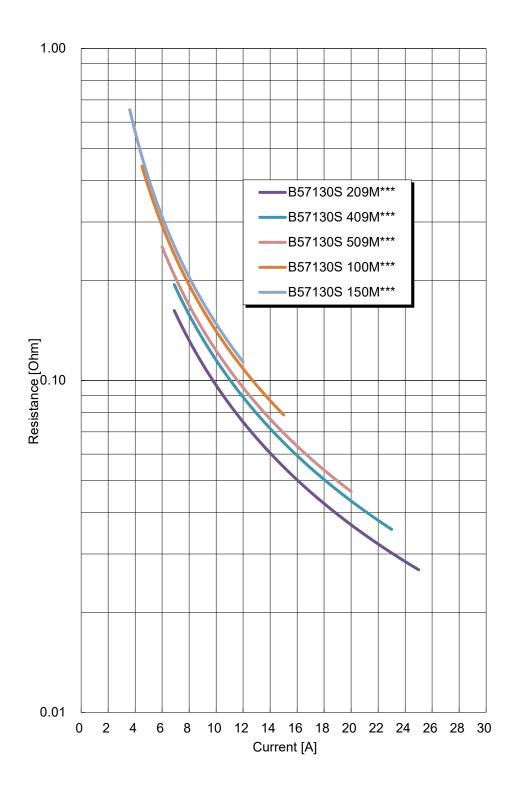
# Resistance versus temperature





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## Resistance versus current





NTC thermistors for inrush current limiting	B57130S0*M000
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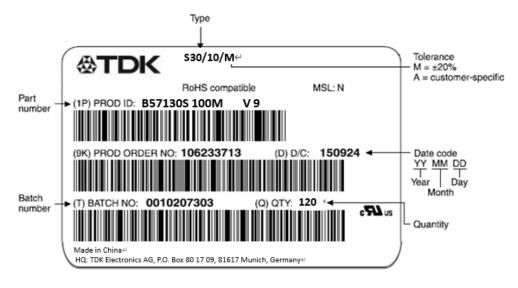
# Packing

Mode	Pcs / unit	Dimensions (mm)
Bulk	120	Approx. x = 220, y = 210, z = 80

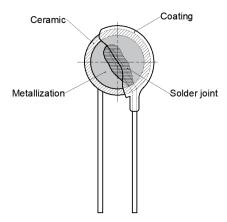
Table 1: Dimensions of unit package

#### Bar code label

The packing of all TDK Electronics components bears a bar code label stating the type, ordering code, quantity, date of manufacture, and batch number. This enables a component to be traced back through the production process, together with its batch and test report.



## Internal structure



The picture above shows the internal structure of the TDK Electronics ICs.

**Note:** The coating may have cracks or chips due to acting mechanical force on the wire. This does not affect the performance of the component. The coating has no insulation voltage / resistance rating.



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## **Inrush Current Limiters (ICLs)**

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## **Cautions and warnings**

## **Storage**

- Store thermistors only in original packaging. Do not open the package before storage.
- Storage conditions in original packaging: storage temperature -25 °C to +45 °C, relative humidity ≤ 75% annual mean, maximum 95%, dew precipitation is inadmissible.
- Avoid contamination of thermistors surface during storage, handling and processing.
- Avoid storage of thermistor in harmful environments like corrosive gases (SO<sub>x</sub>, Cl etc).
- Solder thermistors after shipment from TDK Electronics within the time specified: Leaded components: 24 months

## Handling

- NTC inrush current limiters must not be dropped. Chip-offs must not be caused during handling of NTC inrush current limiters.
- Components must not be touched with bare hands. Wear protective gloves.
- Avoid contamination of thermistor surface during handling.
- In case of exposure of the NTC inrush current limiters to water, electrolytes or other aggressive media, these media can penetrate the coating and reach the surface of the ceramic. Low-ohmic or high-ohmic behavior may occur due to the formation of an electrolyte with metals (silver/lead/tin from metallization or solder). Low-ohmic behavior is caused by electrochemical migration, high-ohmic behavior by dissolving of the electrode. In either case, the functionality of the NTC inrush current limiters cannot be assured.
- Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

#### Bending/twisting leads

- A lead (wire) may be bent at a minimum distance of twice the wire's diameter plus 4 mm from the component head or housing. When bending ensure the wire is mechanically relieved at the component head or housing. The bending radius should be at least 0.75 mm.
- Twisting (torsion) by 180° of a lead bent by 90 ° is permissible at 6 mm from the bottom of the thermistor body.

#### Soldering

- Use resin-type flux or non-activated flux.
- Insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended.
- Complete removal of flux is recommended.



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## **Inrush Current Limiters (ICLs)**

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## **Mounting**

- When thermistors are sealed, potted or over-molded, there must be no mechanical stress caused by thermal expansion during the production process (curing/ over-molding process) and during later operation. The upper category temperature of the thermistor must not be exceeded. Ensure that the materials used (sealing / potting compound and plastic material) are chemically neutral.
- Electrode must not be scratched before/during/after the mounting process.
- Contacts and housings used for assembly with thermistor have to be clean before mounting.
- During operation, the inrush current limiters surface temperature can be very high. Ensure that adjacent components are placed at a sufficient distance from the thermistor to allow for proper cooling of the NTC inrush current limiters.
- Ensure that adjacent materials are designed for operation at temperatures comparable to the surface temperature of the thermistor. Be sure that surrounding parts and materials can withstand this temperature.
- Make sure that inrush current limiters are adequately ventilated to avoid overheating.
- Avoid contamination of thermistor surface during processing.

## Operation

- Use NTC inrush current limiters only within the specified operating temperature range.
- Use NTC inrush current limiters only within the specified voltage and current ranges.
- Environmental conditions must not harm the NTC inrush current limiters. Use NTC inrush current limiters only in normal atmospheric conditions.
- Contact of NTC inrush current limiters with any liquids and solvents should be prevented. It must be ensured that no water enters the NTC inrush current limiters (e.g. through plug terminals). For measurement purposes (checking the specified resistance vs. temperature), the component must not be immersed in water but in suitable liquids (e.g. Galden).
- In case of exposure of the NTC inrush current limiters to water, electrolytes or other aggressive media, these media can penetrate the coating and reach the surface of the ceramic. Low-ohmic or high-ohmic behavior may occur due to the formation of an electrolyte with metals (silver/lead/tin from metallization or solder). Low-ohmic behavior is caused by electrochemical migration, high-ohmic behavior by dissolving of the electrode. In either case, the functionality of the NTC inrush current limiters cannot be assured.
- Be sure to provide an appropriate fail-safe function to prevent secondary product damage caused by malfunction (e.g. use a metal oxide varistor for limitation of overvoltage condition).

This listing does not claim to be complete but merely reflects the experience of TDK Electronics.

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## Important notes

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